DECEMBER 1983 - REVISED MARCH 1988

- Package Options Include Plastic "Small Outline" Packages, Ceramic Chip Carriers and Flat Packages, and Plastic and Ceramic DIPs
- Dependable Texas Instruments Quality and Reliability

description

The '279 offers 4 basic $\overline{S}-\overline{R}$ flip-flop latches in one 16-pin, 300-mil package. Under conventional operation, the $\overline{S}-\overline{R}$ inputs are normally held high. When the \overline{S} input is pulsed low, the Q output will be set high. When \overline{R} is pulsed low, the Q output will be reset low. Normally, the $\overline{S}-\overline{R}$ inputs should not be taken low simultaneously. The Q output will be unpredictable in this condition.

FUNCTION TABLE (each latch)

INP	UTS	OUTPUT
St:	R	Q
н	н	0.0
L	н	H
н	L	L
L	L	н‡

H = high level

L = low level

†For latches with double S inputs:

 Ω_0 = the level of Q before the indicated input conditions were established.

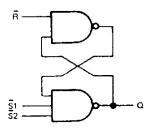
[‡] This configuration is nonstable: that is, it may not persist when the \overline{S} and \overline{R} inputs return to their inactive (high) level.

 $H = both \overline{S}$ inputs high

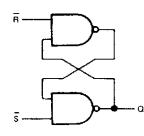
L = one or both \$\overline{5}\$ inputs low

logic diagram (positive logic)

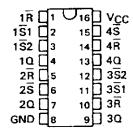
(latches 1 and 3)



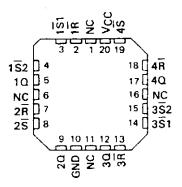
(latches 2 and 4)



SN54279, SN54LS279A . . . J OR W PACKAGE SN74279 . . . N PACKAGE SN74LS279A . . . D OR N PACKAGE (TOP VIEW)

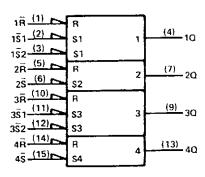


SN54LS279A . . . FK PACKAGE (TOP VIEW)



NC - No internal connection

logic symbol §



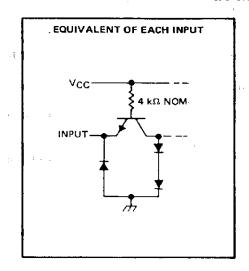
§This symbol is in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12.

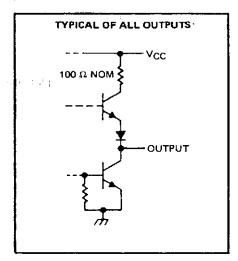
Pin numbers shown are for D, J, N, and W packages.



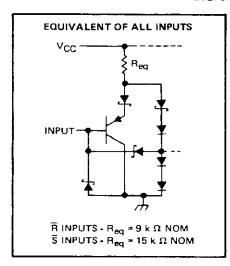
schematics of inputs and outputs

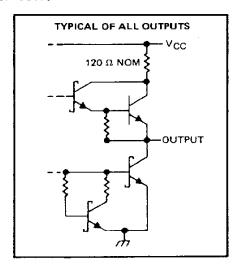
279 CIRCUITS





'LS279A CIRCUITS





absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, VCC (see Note 1)	
Input voltage: '279 ,	5.5 V
' LS279A	
Operating free-air temperature range: SN54' TYP	PES – 55°C to 125°C
SN74' TYF	PES 0° C to 70° C
Storage temperature range	

NOTE 1: Voltage values are with respect to network ground terminal.

recommended operating conditions

			SN54279			SN74279			
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT	
Vcc	Supply voltage	4.5	5	5.5	4.75	5	5.25	V	
VIH	High-level input voltage	2			2	· · · · ·		٧	
VIL	Low-level input voltage			0.8			0.8	٧	
ЮН	High-level output current	Î		- 0.8			- 0.8	mΑ	
loL	Low-level output current			16			16	mΑ	
ŧw	Pulse duration, low	20			20			ns	
ΤA	Operating free-air temperature	- 55		125	0		70	°C	

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

DARAMETER	TEST CONDITIONS		SN54279							
PARAMETER		TEST CONDITIONS			TYP#	MAX	MIN	TYP‡	MAX	UNIT
VIK	V _{CC} = MIN,	I _I = ~ 12 mA				- 1.5			- 1.5	V
Voн	VCC = MIN,	V L = 0.8 V,	I _{OH} ≈ ~ 0.8 mA	2.4	3.4		2.4	3.4		V
VOL	V _{CC} = MIN,	V _{IH} = 2 V,	IOL = 16 mA		0.2	0.4		0.2	0.4	V
I (V _{CC} = MAX,	V _J = 5.5 V				1			1	mA
^Л Н	V _{CC} = MAX,	V ₁ = 2.4 V	<u> </u>			40			40	μA
ارار	V _{CC} = MAX,	V1 = 0.4 V				- 1.6			- 1.6	mA
IOS§	V _{CC} = MAX			- 18		- 55	- 18		- 57	mΑ
¹ cc	V _{CC} = MAX,	See Note 2			18	30		18	30	mA

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

switching characteristics, VCC = 5 V, TA = 25°C (see note 3)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CON	MIN	ТҮР	MAX	UNIT	
^t PLH		Ω	<u> </u>			12	22	ns
tPHL ·	3	-	$R_L = 400 \Omega$,	C _L = 15 pF		9	15	1 '''
tPHL	Ř	Q		- La		15	27	ns

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

[‡] All typical values are at V_{CC} = 5 V, Υ_{A} = 25°C.

Not more than one output should be shorted at a time.

NOTE 2: I_{CC} is measured with all R inputs grounded, all S inputs at 4.5 V, and all outputs open.

SN54LS279A, SN74LS279A QUADRUPLE S-R LATCHES

recommended operating conditions

		Sn	154LS2	79A	SN74LS279A			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Vcc	Supply voltage	4.5	5	5.5	4.75	5	5.25	V
VIH	High-level input voltage	2			2			V
VIL	Low-level input voltage			0.7			8,0	V
loH	High-level output current			- 0.4			- 0.4	mΑ
loL	Low-level output current			4			8	mA
t _w	Pulse duration, low	20			20			ns
TA	Operating free-air temperature	- 55		125	0		70	°c

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER			SN54LS279A			SN	UNIT			
	TEST CONDITIONS			MIN	TYP\$	MAX	MIN	TYP‡	MAX	UNIT
VIK	VCC = MIN,	1 ₁ = 18 mA				– 1.5			- 1.5	V
VoH	V _{CC} = MIN.	VIL = MAX,	I _{OH} = - 0.4 mA	2.5	3.4		2.7	3.4		٧_
	V _{CC} = MIN,	V _{IH} = 2 V,	IOL = 4 mA		0.25	0.4		0.25	0.4	v
VOΓ	VCC = MIN,	V _{IH} = 2 V,	IOL = 8 mA					0.25	0.5	<u> </u>
11	V _{CC} = MAX,	V ₁ = 7 V				0.1			0.1	mΑ
I _{(H}	V _{CC} = MAX,	V ₁ = 2.7 V				20			20	μA
FIL	V _{CC} = MAX,	V ₁ = 0.4 V				- 0.2			- 0.2	mΑ
los \$	V _{CC} = MAX			- 20		- 100	- 20		- 100	mΑ
Icc	V _{CC} = MAX,	See note 2			3.8	7		3.8	7	mΑ

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

NOTE 2: I_{CC} is measured with all R inputs grounded, all S inputs at 4.5 V, and all outputs open.

switching characteristics, VCC = 5 V, TA = 25°C (see note 3)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CO	MIN	TYP	MAX	UNIT	
†PLH					T	12	22	ns.
tPHL.	S	a l	$R_L = 2 k\Omega$,	C _L = 15 pF		13	21	
tPHL	Ā	a		-		15	27	ns

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

^{\$} All typical values are at V_{CC} = 5 V, T_A = 25°C.

⁹ Not more than one output should be shorted at a time, and the duration of the short-circuit should be less than one second.

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